

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







OP181



Features:

- 940nm Wavelength
- Up to 256kbps Operation
- Compliant with Smart Power Meter Standard ANSI C12.18
- Lensed for Maximum Performance
- Reverse Gull Wing Design
- Compatible with OPL6000 Receiver Component

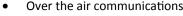


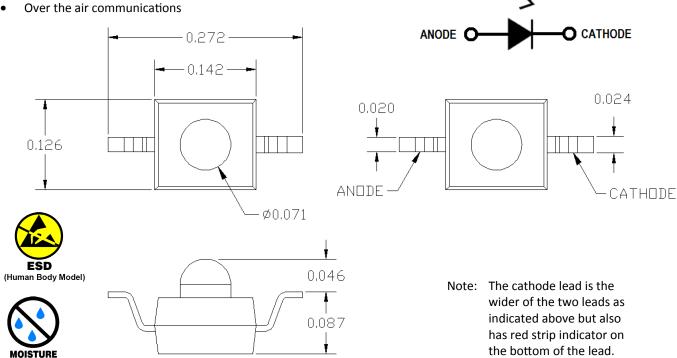
Description:

The OP181 is a surface mount emitter component incorporating a high power 940nm LED. The LED die is lead frame mounted and overmolded, incorporating a lens to achieve excellent beam angle characteristics. The final product provides superior output irradiance at low drive currents. While this part has been designed specifically for the smart power meter industry, other applications are certainly possible.

Applications:

Smart power meter optical port







(Level-4)

Dimensions are ±0.005 unless otherwise specified

OP181



Electrical Specifications

Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

Storage Temperature Range	-55° C to +100° C
Operating Temperature Range	-40° C to +85° C
Reverse Voltage	5 V
Continuous Forward Current ⁽¹⁾	50 mA
Peak Forward Current (1 μs pulse width, 10% duty cycle)	1 A
Power Dissipation ⁽²⁾	130 mW
Solder Reflow Temperature ⁽³⁾	260° C

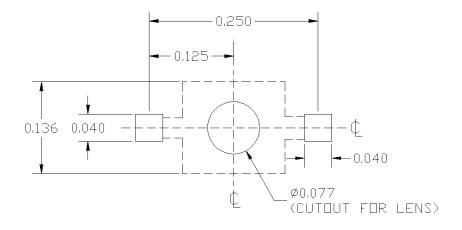
Electrical Characteristics (T_A = 25° C unless otherwise noted)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS	
Po	P_{O} Total Output Power λ_{P} Wavelength at Peak Emission		1.0		mW	I _F = 20 mA	
λ_{P}			940	-	nm		
V _F	Forward Voltage	-	1.55	1.65	V	I _F = 20 mA	
I _R	Reverse Leakage Current	-	-	10	μΑ	V _R = 5V	
θ_{HP}	Emission Angle at Half Power Points	-	10	15	Degree		
t _{r,} t _f	Rise Time, Fall Time	-	0.5	1	μs	f = 1 kHz, 10% - 90%, I _{F(PK)} = 100 mA	

Notes:

- 1. Derate 0.66 mA/°C above 25°C.
- 2. Derate 1.73 mW/°C above 25°C.
- 3. Solder time less than 5 seconds at temperature extreme. Solder time within 5° of peak temperature is 20 to 40 seconds.

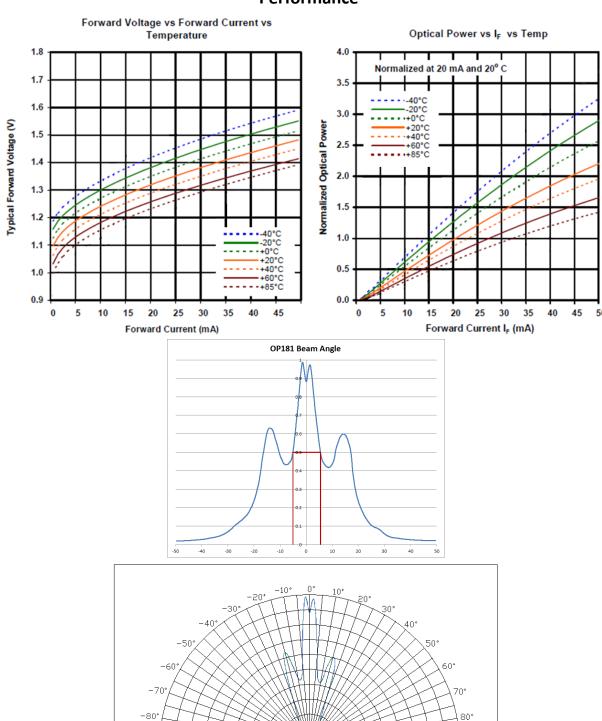
Recommended PCB Layout



OP181



Performance

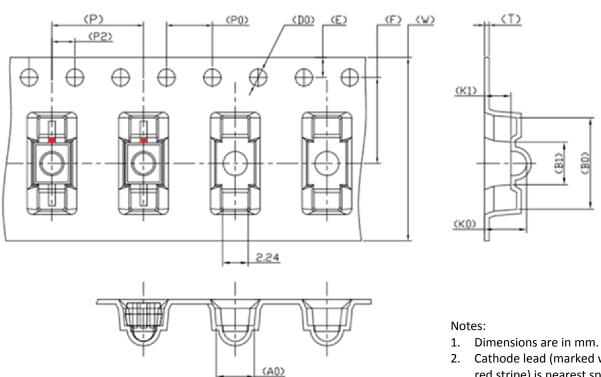


-90°

OP181



Packaging



- Cathode lead (marked with red stripe) is nearest sprocket holes.

W	16.00±0.30	Р	8.00±0.10	ΑO	3.33±0.10	BO	8.00±0.10
Ε	1.75±0.10	PO	4.00±0.10	ΚO	3.66±0.10	В1	3.73±0.10
F	7.50±0.10	P2	2.00±0.10	K1	2.30±0.10		
			ø1.50±8:18				

